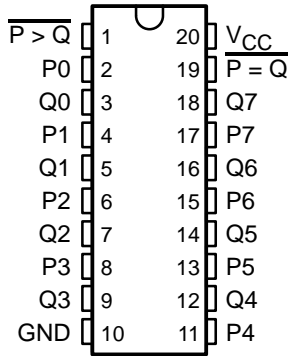


SN54HC684, SN74HC684 8-BIT MAGNITUDE COMPARATORS

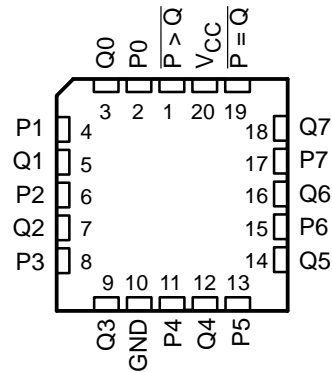
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- Wide Operating Voltage Range of 2 V to 6 V
- High-Current Outputs Drive Up To 10 LSTTL Loads
- Low Power Consumption, 80- μ A Max I_{CC}
- Typical $t_{pd} = 22$ ns
- ± 4 -mA Output Drive at 5 V
- Low Input Current of 1 μ A Max
- Compare Two 8-Bit Words

SN54HC684 . . . J OR W PACKAGE
SN74HC684 . . . DW OR N PACKAGE
(TOP VIEW)



SN54HC684 . . . FK PACKAGE
(TOP VIEW)



description/ordering information

These magnitude comparators perform comparisons of two 8-bit binary or BCD words. These devices provide $P = Q$ and $P > Q$ outputs.

ORDERING INFORMATION

| T_A | PACKAGE† | | ORDERABLE PART NUMBER | TOP-SIDE MARKING |
|----------------|-----------|---------------|-----------------------|------------------|
| -40°C to 85°C | PDIP – N | Tube | SN74HC684N | HC684 |
| | SOIC – DW | Tube | SN74HC684DW | |
| | | Tape and reel | SN74HC684DWR | |
| -55°C to 125°C | CDIP – J | Tube | SNJ54HC684J | SNJ54HC684J |
| | CFP – W | Tube | SNJ54HC684W | SNJ54HC684W |
| | LCCC – FK | Tube | SNJ54HC684FK | SNJ54HC684FK |

† Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.

FUNCTION TABLE

| DATA INPUTS P, Q | OUTPUTS | |
|---------------------|--------------------|--------------------|
| | $\overline{P = Q}$ | $\overline{P > Q}$ |
| $P = Q$ | L | H |
| $P > Q$ | H | L |
| $P < Q$ | H | H |

The $P < Q$ function can be generated by applying $\overline{P = Q}$ and $\overline{P > Q}$ to a 2-input NAND gate.



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 **TEXAS
INSTRUMENTS**

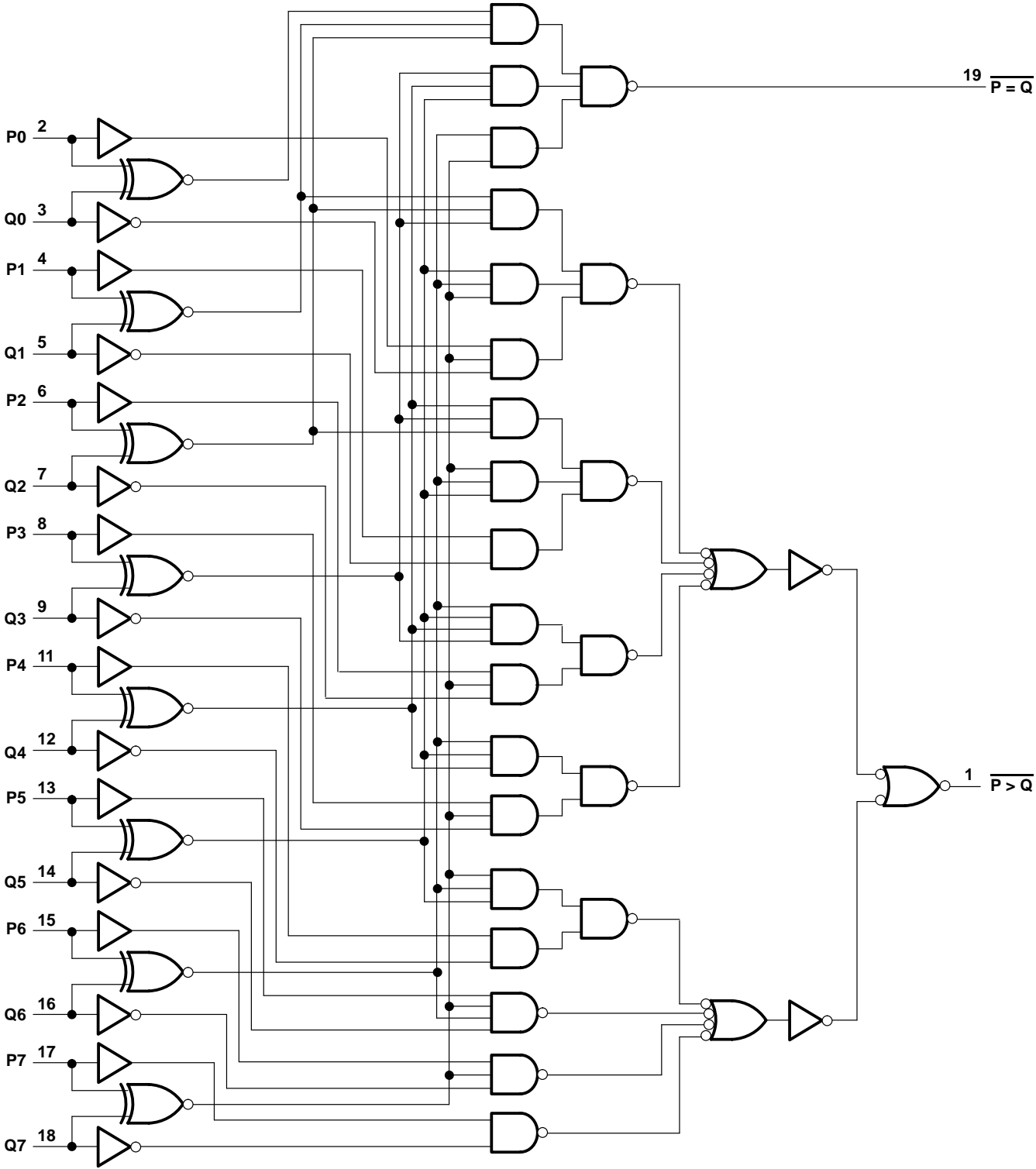
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logic diagram (positive logic)



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SN54HC684, SN74HC684 8-BIT MAGNITUDE COMPARATORS

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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

| | |
|---|----------------------------|
| Supply voltage range, V_{CC} | –0.5 V to 7 V |
| Input voltage range, V_I (see Note 1) | –0.5 V to 7 V |
| Output voltage range, V_O (see Note 1) | –0.5 V to $V_{CC} + 0.5$ V |
| Input clamp current, I_{IK} ($V_I < 0$ or $V_I > V_{CC}$) | ±20 mA |
| Output clamp current, I_{OK} ($V_O < 0$ or $V_O > V_{CC}$) | ±20 mA |
| Continuous output current, I_O ($V_O = 0$ to V_{CC}) | ±25 mA |
| Continuous current through V_{CC} or GND | ±50 mA |
| Package thermal impedance, θ_{JA} (see Note 2): DW package | 58°C/W |
| N package | 69°C/W |
| Storage temperature range, T_{stg} | –65°C to 150°C |

† Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.
2. The package thermal impedance is calculated in accordance with JESD 51-7.

recommended operating conditions (see Note 3)

| | | SN54HC684 | | | SN74HC684 | | | UNIT |
|----------|--|------------------|-----|----------|------------------|------------------|----------|------|
| | | MIN | NOM | MAX | MIN | NOM | MAX | |
| V_{CC} | Supply voltage | 2 | 5 | 6 | 2 | 5 | 6 | V |
| V_{IH} | High-level input voltage | $V_{CC} = 2$ V | | 1.5 | $V_{CC} = 2$ V | | 1.5 | V |
| | | $V_{CC} = 4.5$ V | | 3.15 | $V_{CC} = 4.5$ V | | 3.15 | |
| | | $V_{CC} = 6$ V | | 4.2 | $V_{CC} = 6$ V | | 4.2 | |
| V_{IL} | Low-level input voltage | $V_{CC} = 2$ V | | | 0.5 | $V_{CC} = 2$ V | | 0.5 |
| | | $V_{CC} = 4.5$ V | | | 1.35 | $V_{CC} = 4.5$ V | | 1.35 |
| | | $V_{CC} = 6$ V | | | 1.8 | $V_{CC} = 6$ V | | 1.8 |
| V_I | Input voltage | 0 | | V_{CC} | 0 | | V_{CC} | V |
| V_O | Output voltage | 0 | | V_{CC} | 0 | | V_{CC} | V |
| t_t | Input transition (rise and fall) times | $V_{CC} = 2$ V | | | 1000 | $V_{CC} = 2$ V | | 1000 |
| | | $V_{CC} = 4.5$ V | | | 500 | $V_{CC} = 4.5$ V | | 500 |
| | | $V_{CC} = 6$ V | | | 400 | $V_{CC} = 6$ V | | 400 |
| T_A | Operating free-air temperature | –55 | | 125 | –40 | | 85 | °C |

NOTE 3: All unused inputs of the device must be held at V_{CC} or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.

SN54HC684, SN74HC684 8-BIT MAGNITUDE COMPARATORS

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electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

| PARAMETER | TEST CONDITIONS | | V _{CC} | T _A = 25°C | | | SN54HC684 | | SN74HC684 | | UNIT | | |
|-----------------|---|---------------------------|-----------------|-----------------------|-------|------|-----------|-------|-----------|-------|------|----|----|
| | | | | MIN | TYP | MAX | MIN | MAX | MIN | MAX | | | |
| V _{OH} | V _I = V _{IH} or V _{IL} | I _{OH} = -20 μA | 2 V | 1.9 | 1.998 | | 1.9 | | 1.9 | V | | | |
| | | | 4.5 V | 4.4 | 4.499 | | 4.4 | | 4.4 | | | | |
| | | | 6 V | 5.9 | 5.999 | | 5.9 | | 5.9 | | | | |
| | | I _{OH} = -4 mA | 4.5 V | 3.98 | 4.30 | | 3.7 | | 3.84 | | | | |
| | | I _{OH} = -5.2 mA | 6 V | 5.48 | 5.80 | | 5.2 | | 5.34 | | | | |
| V _{OL} | V _I = V _{IH} or V _{IL} | I _{OL} = 20 μA | 2 V | | 0.002 | 0.1 | | 0.1 | | 0.1 | V | | |
| | | | 4.5 V | | 0.001 | 0.1 | | 0.1 | | 0.1 | | | |
| | | | 6 V | | 0.001 | 0.1 | | 0.1 | | 0.1 | | | |
| | | I _{OL} = 4 mA | 4.5 V | | 0.17 | 0.26 | | 0.4 | | 0.33 | | | |
| | | I _{OL} = 5.2 mA | 6 V | | 0.15 | 0.26 | | 0.4 | | 0.33 | | | |
| I _{IH} | V _I = V _{CC} | | 6 V | | 0.1 | 100 | | 1000 | | 1000 | nA | | |
| I _{IL} | V _I = 0 | | 6 V | | -0.1 | -100 | | -1000 | | -1000 | nA | | |
| I _{CC} | V _I = V _{CC} or 0, I _O = 0 | | 6 V | | | | 8 | | 160 | | 80 | μA | |
| C _i | | | 2 V to 6 V | | 3 | 10 | | 10 | | 10 | | 10 | pF |

switching characteristics over recommended operating free-air temperature range, C_L = 50 pF (unless otherwise noted) (see Figure 1)

| PARAMETER | FROM (INPUT) | TO (OUTPUT) | V _{CC} | T _A = 25°C | | | SN54HC684 | | SN74HC684 | | UNIT |
|-----------------|--------------|-------------|-----------------|-----------------------|-----|-----|-----------|-----|-----------|-----|------|
| | | | | MIN | TYP | MAX | MIN | MAX | MIN | MAX | |
| t _{pd} | P or Q | Any | 2 V | | 130 | 275 | | 413 | | 344 | ns |
| | | | 4.5 V | | 26 | 55 | | 88 | | 69 | |
| | | | 6 V | | 22 | 47 | | 70 | | 58 | |
| t _t | | Any | 2 V | | 38 | 75 | | 110 | | 95 | ns |
| | | | 4.5 V | | 8 | 15 | | 22 | | 19 | |
| | | | 6 V | | 6 | 13 | | 19 | | 16 | |

operating characteristics, T_A = 25°C

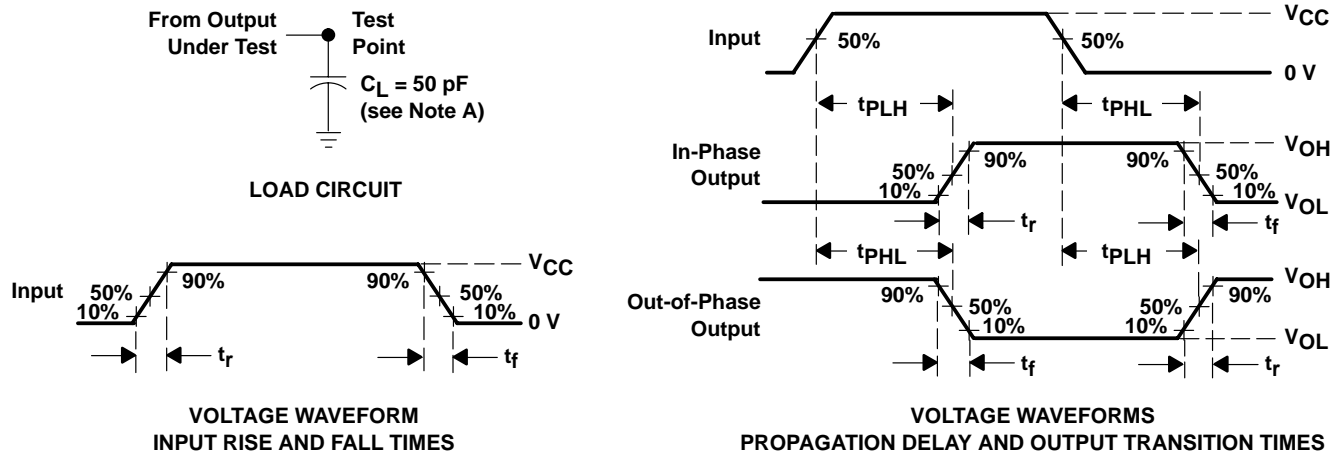
| PARAMETER | TEST CONDITIONS | TYP | UNIT |
|---|-----------------|-----|------|
| C _{pd} Power dissipation capacitance | No load | 40 | pF |

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PARAMETER MEASUREMENT INFORMATION



- NOTES: A. C_L includes probe and test-fixture capacitance.
 B. Phase relationships between waveforms were chosen arbitrarily. All input pulses are supplied by generators having the following characteristics: $PRR \leq 1 \text{ MHz}$, $Z_O = 50 \Omega$, $t_r = 6 \text{ ns}$, $t_f = 6 \text{ ns}$.
 C. The outputs are measured one at a time with one input transition per measurement.
 D. t_{PLH} and t_{PHL} are the same as t_{pd} .

Figure 1. Load Circuit and Voltage Waveforms

PACKAGING INFORMATION

| Orderable Device | Status (1) | Package Type | Package Drawing | Pins | Package Qty | Eco Plan (2) | Lead finish/ Ball material (6) | MSL Peak Temp (3) | Op Temp (°C) | Device Marking (4/5) | Samples |
|------------------|---------------|--------------|-----------------|------|-------------|------------------|--------------------------------------|----------------------|--------------|-------------------------|-------------------------|
| SN74HC684DW | ACTIVE | SOIC | DW | 20 | 25 | RoHS & Green | NIPDAU | Level-1-260C-UNLIM | -40 to 85 | HC684 | Samples |
| SN74HC684N | ACTIVE | PDIP | N | 20 | 20 | RoHS & Non-Green | NIPDAU | N / A for Pkg Type | -40 to 85 | SN74HC684N | Samples |

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) **RoHS:** TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

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Green: TI defines "Green" to mean the content of Chlorine (Cl) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

(3) MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "-" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

(6) Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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TUBE


*All dimensions are nominal

| Device | Package Name | Package Type | Pins | SPQ | L (mm) | W (mm) | T (μm) | B (mm) |
|-------------|--------------|--------------|------|-----|--------|--------|--------|--------|
| SN74HC684DW | DW | SOIC | 20 | 25 | 507 | 12.83 | 5080 | 6.6 |
| SN74HC684N | N | PDIP | 20 | 20 | 506 | 13.97 | 11230 | 4.32 |

N (R-PDIP-T**)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



- NOTES:
- A. All linear dimensions are in inches (millimeters).
 - B. This drawing is subject to change without notice.
 - Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
 - The 20 pin end lead shoulder width is a vendor option, either half or full width.

DW0020A



PACKAGE OUTLINE

SOIC - 2.65 mm max height

SOIC



4220724/A 05/2016

NOTES:

1. All linear dimensions are in millimeters. Dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.15 mm per side.
4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.43 mm per side.
5. Reference JEDEC registration MS-013.

EXAMPLE BOARD LAYOUT

DW0020A

SOIC - 2.65 mm max height

SOIC



LAND PATTERN EXAMPLE
SCALE:6X



SOLDER MASK DETAILS

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NOTES: (continued)

- 6. Publication IPC-7351 may have alternate designs.
- 7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

EXAMPLE STENCIL DESIGN

DW0020A

SOIC - 2.65 mm max height

SOIC



SOLDER PASTE EXAMPLE
BASED ON 0.125 mm THICK STENCIL
SCALE:6X

4220724/A 05/2016

NOTES: (continued)

8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
9. Board assembly site may have different recommendations for stencil design.

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